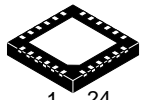


MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

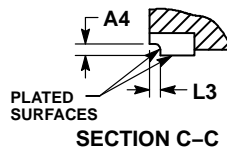
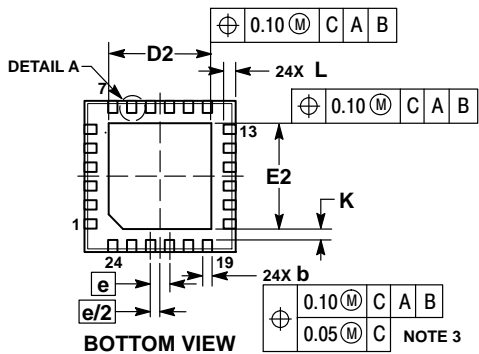
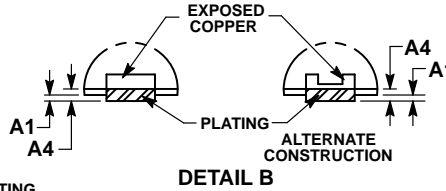
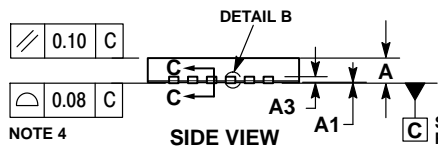
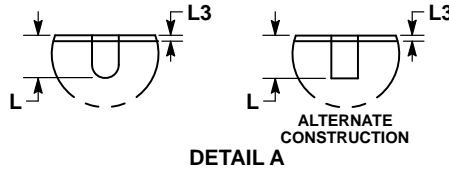
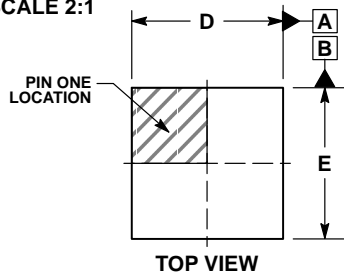
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SCALE 2:1

QFNW24 5x5, 0.65P CASE 484AF ISSUE A

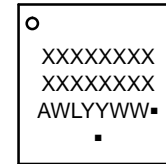
DATE 07 AUG 2018



- NOTES:
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 - CONTROLLING DIMENSION: MILLIMETERS.
 - DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
 - COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| MILLIMETERS | | | |
|-------------|----------|------|------|
| DIM | MIN | NOM | MAX |
| A | 0.80 | 0.85 | 0.90 |
| A1 | --- | --- | 0.05 |
| A3 | 0.20 REF | | |
| A4 | 0.10 | --- | --- |
| b | 0.25 | 0.30 | 0.35 |
| D | 4.90 | 5.00 | 5.10 |
| D2 | 3.40 | 3.50 | 3.60 |
| E | 4.90 | 5.00 | 5.10 |
| E2 | 3.40 | 3.50 | 3.60 |
| e | 0.65 BSC | | |
| K | 0.35 REF | | |
| L | 0.30 | 0.40 | 0.50 |
| L3 | 0.05 REF | | |

GENERIC MARKING DIAGRAM*

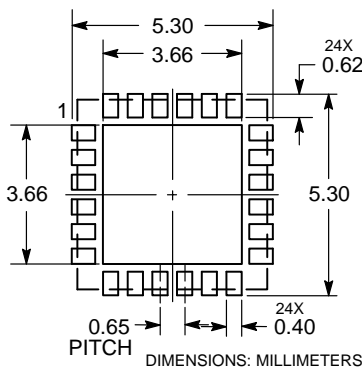


- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- YY = Year
- WW = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED SOLDERING FOOTPRINT



| | | |
|-------------------------|--------------------------|--|
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| DESCRIPTION: | QFNW24 5x5, 0.65P | PAGE 1 OF 1 |

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